

## **Declaration and Power of Attorney**

As a below named inventor, I hereby declare:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the following invention:

Title: Method, Device And System For Controlling Heating Of Circuits

       The specification of which is attached hereto.

  X   The specification of which was filed on August 18, 2006

as Application Serial No. 10/589,912

and was amended on August 18, 2006 (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I hereby claim foreign priority benefits under 35 U.S.C. §§ 119(a)-(d) or (f), or 365(b) of any foreign application(s) for patent, inventor's or plant breeder's rights certificate(s), or 365(a) of any PCT international application which designated at least one country other than the United States of America.

**Prior Foreign Application(s):**

JP 2004-081739 filed March 19, 2004

JP 2004-180281 filed June 17, 2004

PCT/JP2005/004840 filed March 17, 2005

I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. § 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under § 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint all practitioners of Kaplan Gilman Gibson & Dernier LLP associated with **Customer Number 27538** jointly and severally as my attorneys and/ or agents with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith.

Direct correspondence to: Matthew B. Dernier, Esq. at the address associated with **Customer Number 27538**.

Full name of **FIRST NAMED INVENTOR**:

Kazuaki YAZAWA

Inventor's Signature:

矢澤 和明

Date:

September 26, 2006

Residence:

Chiba, Japan

Citizenship:

Japan

Post Office Address:

c/o Sony Computer Entertainment Inc.

2-6-21, Minami-Aoyama, Minato-ku

Tokyo 107-0062, Japan

Full name of **SECOND NAMED INVENTOR**:

Tetsuji TAMURA

Inventor's Signature:

田村 哲司

Date:

September 26, 2006

Residence:

Tokyo, Japan

Citizenship:

Japan

Post Office Address:

c/o Sony Computer Entertainment Inc.

2-6-21, Minami-Aoyama, Minato-ku

Tokyo 107-0062, Japan